Filing Date: January 15, 2004

Title: TOP OR BOTTOM PART FOR A MODULE CHASSIS

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## **IN THE CLAIMS**

Please amend the claims as follows:

the circuit board when the circuit board is completely inserted.

- 1. (Currently Amended) A top or bottom part for a module chassis, comprising:

  a frame having front and rear frame strips; and

  guide rails that are positioned between the front frame strip and the rear frame strip and
  aligned in the direction of insertion for the mounting of a circuit board of a plug-in module,
  wherein the guide rails, in cross section, are formed in a u-shape and include a bottom and two
  sidewalls, at least one of the sidewalls having at least one lateral void bulge oriented in a
  direction from an inside of the guide rails to an outside, the void bulge of the at least one
  sidewall corresponding with at least one electrically conductive contact area at a lower edge of
- 2. (Currently Amended) The top or bottom part of claim 1, wherein both sidewalls of the guide rail each have at least one void bulge.
- 3. (Currently Amended) The top or bottom part of claim 2, wherein the voids <u>bulges</u> are positioned in pairs opposite each other.
- 4. (Original) The top or bottom part of claim 1, wherein a distance between the sidewalls of the guide rail corresponds with a thickness of the circuit board.
- 5. (Currently Amended) The top or bottom part of claim 1, wherein the sidewalls are separated from the bottom of the guide rail in the area of the at least one void <u>bulge</u> so that a slit-like opening is created.
- 6. (Currently Amended) The top or bottom part of claim 1, wherein a junction between the at least one sidewall and the at least one void <u>bulge</u> is slanted or rounded.
- 7. (Currently Amended) A top or bottom part for a module chassis, comprising:

AMENDMENT AND RESPONSE UNDER 37 CFR § 1.111

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a frame; and

one or more guide rails attached to the frame and adapted to hold a circuit board, each guide rail having a bottom and a pair of sidewalls, at least one of the pair of sidewalls having at

least one lateral void bulge oriented in a direction from an inside of the guide rails to an outside.

8. (Currently Amended) The top or bottom part of claim 7, wherein the at least one void

bulge of the at least one sidewall corresponds with at least one contact area at a lower edge of a

circuit board.

9. (Original) The top or bottom part of claim 7, wherein the one or more guide rails are

aligned in the direction of insertion for the mounting of the circuit board.

10. (Currently Amended) The top or bottom part of claim 7, wherein both sidewalls of the

guide rail each have at least one void bulge.

11. (Currently Amended) The top or bottom part of claim 10, wherein the voids bulges are

positioned in pairs opposite each other.

12. (Original) The top or bottom part of claim 7, wherein a distance between the sidewalls of

the guide rail corresponds with a thickness of the circuit board.

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